

Vishay General Semiconductor

Surface Mount Glass Passivated Rectifier



DO-214AB (SMC)

PRIMARY CHARACTERISTICS								
I _{F(AV)} 3.0 A								
V_{RRM}	50 V to 1000 V							
I _{FSM}	100 A							
I _R	10 μΑ							
V _F	1.15 V							
T _J max.	150 °C							

FEATURES

- · Low profile package
- · Ideal for automated placement
- · Glass passivated chip junction
- Low forward voltage drop
- · Low leakage current
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Solder dip 260 °C, 40 s
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC

TYPICAL APPLICATIONS

For use in general purpose rectification of power supplies, inverters, converters and freewheeling diodes for consumer, automotive and telecommunication.

MECHANICAL DATA

Case: DO-214AB (SMC)

Epoxy meets UL 94V-0 flammability rating

Terminals: Matte tin plated leads, solderable per

J-STD-002 and JESD22-B102

E3 suffix for consumer grade, meets JESD 201 class 1A whisker test, HE3 suffix for high reliability grade (AEC Q101 qualified), meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)									
PARAMETER	SYMBOL	S3A	S3B	S3D	S3G	S3J	S3K	S3M	UNIT
Device marking code		SA	SB	SD	SG	SJ	SK	SM	
Maximum recurrent peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current at T _L = 103 °C	I _{F(AV)}	3.0							Α
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	100						Α	
Operating junction and storage temperature range	T _J , T _{STG}	G - 55 to + 150							°C

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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)											
PARAMETER	TEST CONDITIONS		SYMBOL	S3A	S3B	S3D	S3G	S3J	S3K	S3M	UNIT
Maximum instantaneous forward voltage	2.5 A		V _F	1.15				V			
Maximum DC reverse current at rated DC blocking voltage		T _A = 25 °C T _A = 125 °C	I _R	10 250					μΑ		
Typical reverse recovery time	I _F = 0.5 I _{rr} = 0.2	A, I _R = 1.0 A, 5 A	t _{rr}	2.5			2.5				μs
Typical junction capacitance	4.0 V, 1	MHz	CJ	60				pF			

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)							
PARAMETER	METER SYMBOL S3A S3B S3D S3G S3J S3K S3M UN						UNIT
Typical thermal resistance ⁽¹⁾	$egin{array}{c} {\sf R}_{ heta {\sf JA}} \ {\sf R}_{ heta {\sf JL}} \end{array}$					°C/W	

Note:

(1) Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.3 x 0.3" (8.0 x 8.0 mm) copper pad area

ORDERING INFORMATION (Example)									
PREFERRED P/N	UNIT WEIGHT (g)	REFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE					
S3J-E3/57T	0.211	57T	850	7" diameter plastic tape and reel					
S3J-E3/9AT	0.211	9AT	3500	13" diameter plastic tape and reel					
S3JHE3/57T ⁽¹⁾	0.211	57T	850	7" diameter plastic tape and reel					
S3JHE3/9AT ⁽¹⁾	0.211	9AT	3500	13" diameter plastic tape and reel					

Note:

(1) Automotive grade AEC Q101 qualified

RATINGS AND CHARACTERISTICS CURVES

(T_A = 25 °C unless otherwise noted)

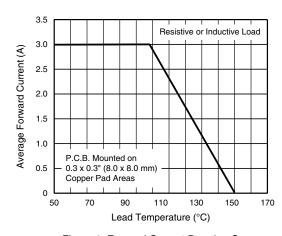


Figure 1. Forward Current Derating Curve

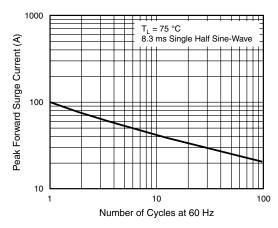


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current



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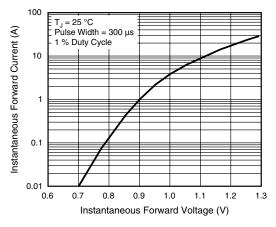
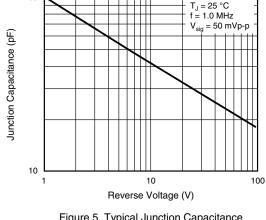


Figure 3. Typical Instantaneous Forward Characteristics



100

Figure 5. Typical Junction Capacitance

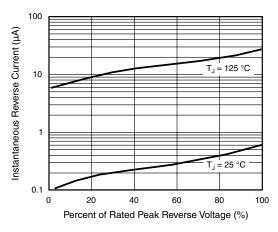


Figure 4. Typical Reverse Characteristics

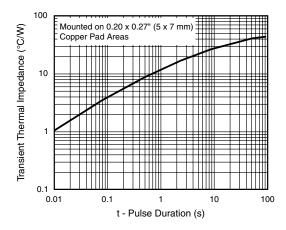
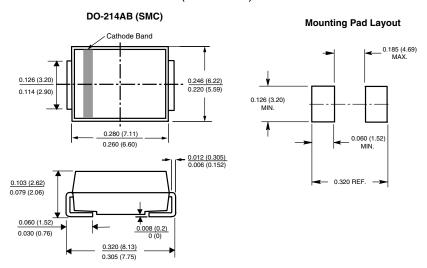


Figure 6. Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



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